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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	8MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	4KB (2K x 16)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	232 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.59x16.59)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17lc42a-08i-l

#### RESET 4.0

The PIC17CXX differentiates between various kinds of

- Power-on Reset (POR)
- MCLR reset during normal operation
- WDT Reset (normal operation)

Some registers are not affected in any reset condition: their status is unknown on POR and unchanged in any other reset. Most other registers are forced to a "reset state" on Power-on Reset (POR), on MCLR or WDT Reset and on MCLR reset during SLEEP. They are not affected by a WDT Reset during SLEEP, since this reset is viewed as the resumption of normal operation. The TO and PD bits are set or cleared differently in different reset situations as indicated in Table 4-3. These bits are used in software to determine the nature of reset. See Table 4-4 for a full description of reset states of all registers.

Note: While the device is in a reset state, the internal phase clock is held in the Q1 state. Any processor mode that allows external execution will force the RE0/ALE pin as a low output and the RE1/OE and RE2/WR pins as high outputs.

A simplified block diagram of the on-chip reset circuit is shown in Figure 4-1.

#### 4.1 Power-on Reset (POR), Power-up Timer (PWRT), and Oscillator Start-up Timer (OST)

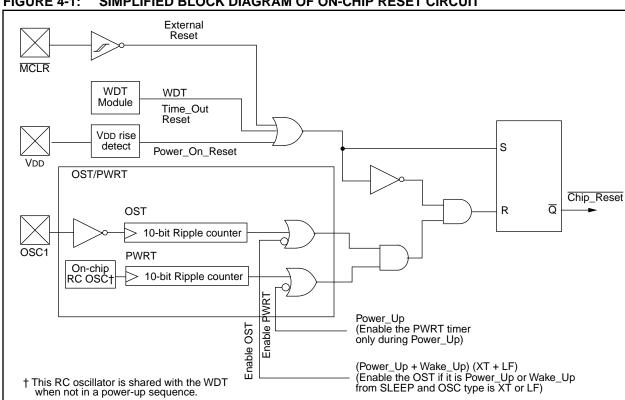
#### 4.1.1 POWER-ON RESET (POR)

The Power-on Reset circuit holds the device in reset until VDD is above the trip point (in the range of 1.4V -2.3V). The PIC17C42 does not produce an internal reset when VDD declines. All other devices will produce an internal reset for both rising and falling VDD. To take advantage of the POR, just tie the MCLR/VPP pin directly (or through a resistor) to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A minimum rise time for VDD is required. See Electrical Specifications for details.

#### 4.1.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 96 ms time-out (nominal) on power-up. This occurs from rising edge of the POR signal and after the first rising edge of MCLR (detected high). The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as the PWRT is active. In most cases the PWRT delay allows the VDD to rise to an acceptable level.

The power-up time delay will vary from chip to chip and to VDD and temperature. See DC parameters for details.



SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT FIGURE 4-1:

#### 6.0 MEMORY ORGANIZATION

There are two memory blocks in the PIC17C4X; program memory and data memory. Each block has its own bus, so that access to each block can occur during the same oscillator cycle.

The data memory can further be broken down into General Purpose RAM and the Special Function Registers (SFRs). The operation of the SFRs that control the "core" are described here. The SFRs used to control the peripheral modules are described in the section discussing each individual peripheral module.

#### 6.1 **Program Memory Organization**

PIC17C4X devices have a 16-bit program counter capable of addressing a 64K x 16 program memory space. The reset vector is at 0000h and the interrupt vectors are at 0008h, 0010h, 0018h, and 0020h (Figure 6-1).

#### 6.1.1 PROGRAM MEMORY OPERATION

The PIC17C4X can operate in one of four possible program memory configurations. The configuration is selected by two configuration bits. The possible modes are:

- Microprocessor
- Microcontroller
- Extended Microcontroller
- Protected Microcontroller

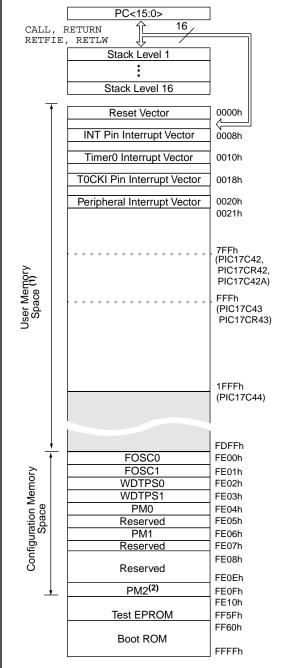
The microcontroller and protected microcontroller modes only allow internal execution. Any access beyond the program memory reads unknown data. The protected microcontroller mode also enables the code protection feature.

The extended microcontroller mode accesses both the internal program memory as well as external program memory. Execution automatically switches between internal and external memory. The 16-bits of address allow a program memory range of 64K-words.

The microprocessor mode only accesses the external program memory. The on-chip program memory is ignored. The 16-bits of address allow a program memory range of 64K-words. Microprocessor mode is the default mode of an unprogrammed device.

The different modes allow different access to the configuration bits, test memory, and boot ROM. Table 6-1 lists which modes can access which areas in memory. Test Memory and Boot Memory are not required for normal operation of the device. Care should be taken to ensure that no unintended branches occur to these areas.

FIGURE 6-1: PROGRAM MEMORY MAP AND STACK



- Note 1: User memory space may be internal, external, or both. The memory configuration depends on the processor mode.
  - 2: This location is reserved on the PIC17C42.

## FIGURE 7-3: TLRD INSTRUCTION OPERATION

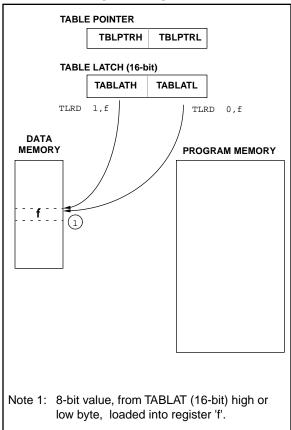
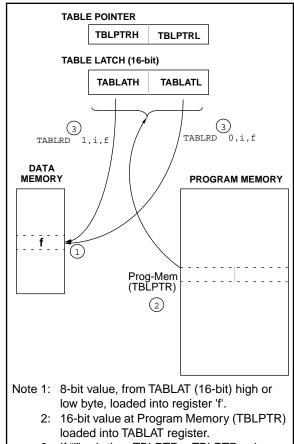


FIGURE 7-4: TABLRD INSTRUCTION OPERATION



3: If "i" = 1, then TBLPTR = TBLPTR + 1, If "i" = 0, then TBLPTR is unchanged.

FIGURE 9-2: RA2 AND RA3 BLOCK DIAGRAM

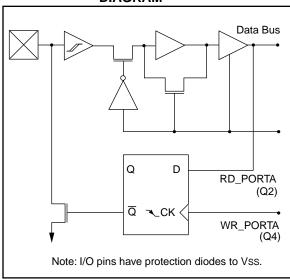


FIGURE 9-3: RA4 AND RA5 BLOCK DIAGRAM

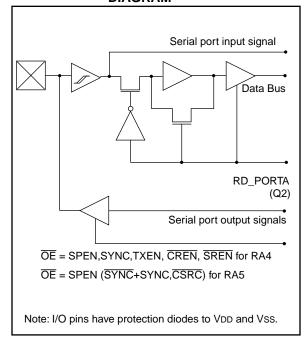


TABLE 9-1: PORTA FUNCTIONS

Name	Bit0	Buffer Type	Function
RA0/INT	bit0	ST	Input or external interrupt input.
RA1/T0CKI	bit1	ST	Input or clock input to the TMR0 timer/counter, and/or an external interrupt input.
RA2	bit2	ST	Input/Output. Output is open drain type.
RA3	bit3	ST	Input/Output. Output is open drain type.
RA4/RX/DT	bit4	ST	Input or USART Asynchronous Receive or USART Synchronous Data.
RA5/TX/CK	bit5	ST	Input or USART Asynchronous Transmit or USART Synchronous Clock.
RBPU	bit7	_	Control bit for PORTB weak pull-ups.

Legend: ST = Schmitt Trigger input.

TABLE 9-2: REGISTERS/BITS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
10h, Bank 0	PORTA	RBPU	-	RA5	RA4	RA3	RA2	RA1/T0CKI	RA0/INT	0-xx xxxx	0-uu uuuu
05h, Unbanked	T0STA	INTEDG	T0SE	T0CS	PS3	PS2	PS1	PS0	_	0000 000-	0000 000-
13h, Bank 0	RCSTA	SPEN	RC9	SREN	CREN	_	FERR	OERR	RC9D	0000 -00x	0000 -00u
15h, Bank 0	TXSTA	CSRC	TX9	TXEN	SYNC	_	_	TRMT	TX9D	00001x	00001u

Legend: x = unknown, u = unchanged,  $- = unimplemented reads as '0'. Shaded cells are not used by PORTA. Note 1: Other (non power-up) resets include: external reset through <math>\overline{MCLR}$  and the Watchdog Timer Reset.

#### 9.2 PORTB and DDRB Registers

PORTB is an 8-bit wide bi-directional port. The corresponding data direction register is DDRB. A '1' in DDRB configures the corresponding port pin as an input. A '0' in the DDRB register configures the corresponding port pin as an output. Reading PORTB reads the status of the pins, whereas writing to it will write to the port latch.

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is done by clearing the RBPU (PORTA<7>) bit. The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are enabled on any reset.

PORTB also has an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (i.e. any RB7:RB0 pin configured as an output is excluded from the interrupt on change comparison). The input pins (of RB7:RB0) are compared with the value in the PORTB data latch. The "mismatch" outputs of RB7:RB0 are OR'ed together to generate the PORTB Interrupt Flag RBIF (PIR<7>).

This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt by:

- Read-Write PORTB (such as; MOVPF PORTB, PORTB). This will end mismatch condition.
- b) Then, clear the RBIF bit.

A mismatch condition will continue to set the RBIF bit. Reading then writing PORTB will end the mismatch condition, and allow the RBIF bit to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on this port, allows easy interface to a key pad and make it possible for wake-up on key-depression. For an example, refer to AN552 in the *Embedded Control Handbook*.

The interrupt on change feature is recommended for wake-up on operations where PORTB is only used for the interrupt on change feature and key depression operation.

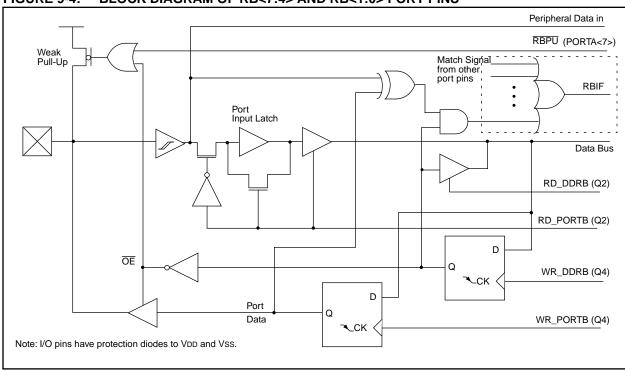


FIGURE 9-4: BLOCK DIAGRAM OF RB<7:4> AND RB<1:0> PORT PINS

#### 11.1 <u>Timer0 Operation</u>

When the TOCS (TOSTA<5>) bit is set, TMR0 increments on the internal clock. When TOCS is clear, TMR0 increments on the external clock (RA1/TOCKI pin). The external clock edge can be configured in software. When the TOSE (TOSTA<6>) bit is set, the timer will increment on the rising edge of the RA1/TOCKI pin. When TOSE is clear, the timer will increment on the falling edge of the RA1/TOCKI pin. The prescaler can be programmed to introduce a prescale of 1:1 to 1:256. The timer increments from 0000h to FFFFh and rolls over to 0000h. On overflow, the TMR0 Interrupt Flag bit (TOIF) is set. The TMR0 interrupt can be masked by clearing the corresponding TMR0 Interrupt Enable bit (TOIE). The TMR0 Interrupt Flag bit (TOIF) is automatically cleared when vectoring to the TMR0 interrupt vector.

#### 11.2 <u>Using Timer0 with External Clock</u>

When the external clock input is used for Timer0, it is synchronized with the internal phase clocks. Figure 11-3 shows the synchronization of the external clock. This synchronization is done after the prescaler. The output of the prescaler (PSOUT) is sampled twice in every instruction cycle to detect a rising or a falling edge. The timing requirements for the external clock are detailed in the electrical specification section for the desired device.

#### 11.2.1 DELAY FROM EXTERNAL CLOCK EDGE

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time TMR0 is actually incremented. Figure 11-3 shows that this delay is between 3Tosc and 7Tosc. Thus, for example, measuring the interval between two edges (e.g. period) will be accurate within  $\pm 4Tosc$  ( $\pm 121$  ns @ 33 MHz).

FIGURE 11-2: TIMERO MODULE BLOCK DIAGRAM

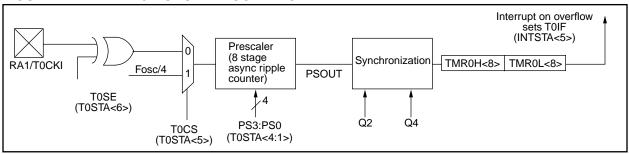
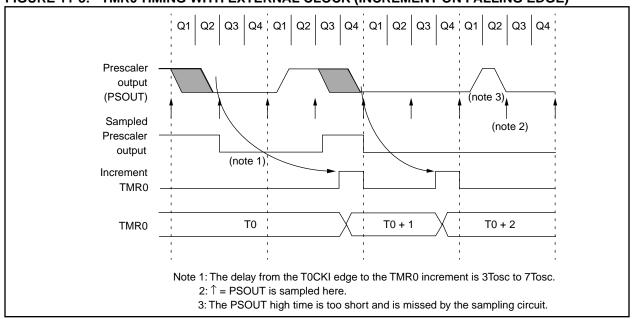


FIGURE 11-3: TMR0 TIMING WITH EXTERNAL CLOCK (INCREMENT ON FALLING EDGE)



#### 12.1.2 TIMER1 & TIMER2 IN 16-BIT MODE

To select 16-bit mode, the T16 bit must be set. In this mode TMR1 and TMR2 are concatenated to form a 16-bit timer (TMR2:TMR1). The 16-bit timer increments until it matches the 16-bit period register (PR2:PR1). On the following timer clock, the timer value is reset to 0h, and the TMR1IF bit is set.

When selecting the clock source for the 16-bit timer, the TMR1CS bit controls the entire 16-bit timer and TMR2CS is a "don't care." When TMR1CS is clear, the timer increments once every instruction cycle (Fosc/4). When TMR1CS is set, the timer increments on every falling edge of the RB4/TCLK12 pin. For the 16-bit timer to increment, both TMR1ON and TMR2ON bits must be set (Table 12-1).

## 12.1.2.1 EXTERNAL CLOCK INPUT FOR TMR1:TMR2

When TMR1CS is set, the 16-bit TMR2:TMR1 increments on the falling edge of clock input TCLK12. The input on the RB4/TCLK12 pin is sampled and synchronized by the internal phase clocks twice every instruction cycle. This causes a delay from the time a falling edge appears on RB4/TCLK12 to the time TMR2:TMR1 is actually incremented. For the external clock input timing requirements, see the Electrical Specification section.

TABLE 12-1: TURNING ON 16-BIT TIMER

TMR2ON	TMR10N	Result
1	1	16-bit timer (TMR2:TMR1) ON
0	1	Only TMR1 increments
х	0	16-bit timer OFF

FIGURE 12-4: TMR1 AND TMR2 IN 16-BIT TIMER/COUNTER MODE

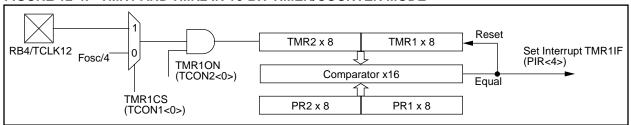


TABLE 12-2: SUMMARY OF TIMER1 AND TIMER2 REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
16h, Bank 3	TCON1	CA2ED1	CA2ED0	CA1ED1	CA1ED0	T16	TMR3CS	TMR2CS	TMR1CS	0000 0000	0000 0000
17h, Bank 3	TCON2	CA2OVF	CA10VF	PWM2ON	PWM10N	CA1/PR3	TMR3ON	TMR2ON	TMR10N	0000 0000	0000 0000
10h, Bank 2 TMR1 Timer1 register									xxxx xxxx	uuuu uuuu	
11h, Bank 2	n, Bank 2 TMR2 Timer2 register							xxxx xxxx	uuuu uuuu		
16h, Bank 1	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
17h, Bank 1	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000
07h, Unbanked	INTSTA	PEIF	T0CKIF	TOIF	INTF	PEIE	T0CKIE	TOIE	INTE	0000 0000	0000 0000
06h, Unbanked	CPUSTA	_	_	STKAV	GLINTD	TO	PD	_	_	11 11	11 qq
14h, Bank 2	PR1	Timer1 pe	riod registe	r						xxxx xxxx	uuuu uuuu
15h, Bank 2	PR2	Timer2 pe	riod registe	r						xxxx xxxx	uuuu uuuu
10h, Bank 3	PW1DCL	DC1	DC0	_	_	_	_	_	_	xx	uu
11h, Bank 3	PW2DCL	DC1	DC0	TM2PW2	_	_	_	_	_	xx0	uu0
12h, Bank 3	PW1DCH	DC9	DC8	DC7	DC6	DC5	DC4	DC3	DC2	xxxx xxxx	uuuu uuuu
13h, Bank 3	PW2DCH	DC9	DC8	DC7	DC6	DC5	DC4	DC3	DC2	xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as a '0', q - value depends on condition, shaded cells are not used by Timer1 or Timer2.

Note 1: Other (non power-up) resets include: external reset through MCLR and WDT Timer Reset.

# 13.0 UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (USART) MODULE

The USART module is a serial I/O module. The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices such as CRT terminals and personal computers, or it can be configured as a half duplex synchronous system that can communicate with peripheral devices such as A/D or D/A integrated circuits, Serial EEPROMs etc. The USART can be configured in the following modes:

- Asynchronous (full duplex)
- Synchronous Master (half duplex)
- Synchronous Slave (half duplex)

The SPEN (RCSTA<7>) bit has to be set in order to configure RA4 and RA5 as the Serial Communication Interface.

The USART module will control the direction of the RA4/RX/DT and RA5/TX/CK pins, depending on the states of the USART configuration bits in the RCSTA and TXSTA registers. The bits that control I/O direction are:

- SPEN
- TXEN
- SREN
- CREN
- CSRC

The Transmit Status And Control Register is shown in Figure 13-1, while the Receive Status And Control Register is shown in Figure 13-2.

#### FIGURE 13-1: TXSTA REGISTER (ADDRESS: 15h, BANK 0)

<u>R/W - 0</u> CSRC	R/W - 0 TX9	R/W - 0 TXEN	R/W - 0 SYNC	<u>U - 0</u>	U - 0 —	R - 1 TRMT	R/W - x TX9D	R = Readable bit
oit7	11.15						bit0	W = Writable bit -n = Value at POR reset (x = unknown)
oit 7:	CSRC: C Synchron 1 = Maste 0 = Slave Asynchron Don't care	ous mode r Mode (C mode (Clo nous mod	lock gene	rated inte	rnally from I	BRG)		
oit 6:	<b>TX9</b> : 9-bit 1 = Select 0 = Select	s 9-bit tra	nsmission					
oit 5:	TXEN: Tra 1 = Transr 0 = Transr SREN/CR	nit enable nit disable	d d	in SYNC	mode			
oit 4:	SYNC: US (Synchror 1 = Synch 0 = Async	nous/Asyn ronous m	chronous) ode					
oit 3-2:	Unimplen	nented: R	ead as '0'					
oit 1:	<b>TRMT</b> : Tra 1 = TSR e 0 = TSR fi	mpty	ft Register	(TSR) E	mpty bit			
oit 0:	TYQD: Oth	hit of tran	emit data	(can he i	sed to calci	ulated the	parity in so	ftware)

## 13.3.2 USART SYNCHRONOUS MASTER RECEPTION

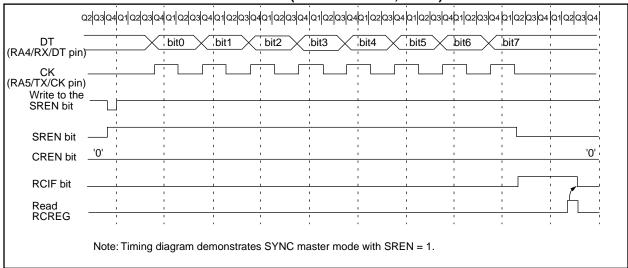
Once synchronous mode is selected, reception is enabled by setting either the SREN (RCSTA<5>) bit or the CREN (RCSTA<4>) bit. Data is sampled on the RA4/RX/DT pin on the falling edge of the clock. If SREN is set, then only a single word is received. If CREN is set, the reception is continuous until CREN is reset. If both bits are set, then CREN takes precedence. After clocking the last bit, the received data in the Receive Shift Register (RSR) is transferred to RCREG (if it is empty). If the transfer is complete, the interrupt bit RCIF (PIR<0>) is set. The actual interrupt can be enabled/disabled by setting/clearing the RCIE (PIE<0>) bit. RCIF is a read only bit which is RESET by the hardware. In this case it is reset when RCREG has been read and is empty. RCREG is a double buffered register; i.e., it is a two deep FIFO. It is possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte to begin shifting into the RSR. On the clocking of the last bit of the third byte, if RCREG is still full, then the overrun error bit OERR (RCSTA<1>) is set. The word in the RSR will be lost. RCREG can be read twice to retrieve the two bytes in the FIFO. The OERR bit has to be cleared in software. This is done by clearing the CREN bit. If OERR bit is set, transfers from RSR to RCREG are inhibited, so it is essential to clear OERR bit if it is set. The 9th receive bit is buffered the same way as the receive data. Reading the RCREG register will allow the RX9D and FERR bits to be loaded with values for the next received data: therefore, it is essential for the user to read the RCSTA register before reading RCREG in order not to lose the old FERR and RX9D information.

Steps to follow when setting up a Synchronous Master Reception:

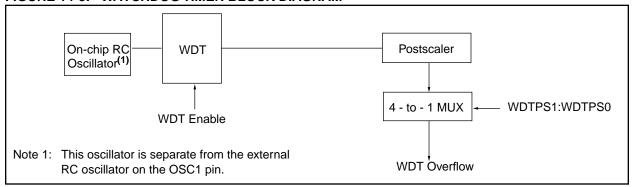
- Initialize the SPBRG register for the appropriate baud rate. See Section 13.1 for details.
- Enable the synchronous master serial port by setting bits SYNC, SPEN, and CSRC.
- 3. If interrupts are desired, then set the RCIE bit.
- 4. If 9-bit reception is desired, then set the RX9 bit.
- 5. If a single reception is required, set bit SREN. For continuous reception set bit CREN.
- The RCIF bit will be set when reception is complete and an interrupt will be generated if the RCIE bit was set.
- 7. Read RCSTA to get the ninth bit (if enabled) and determine if any error occurred during reception.
- 8. Read the 8-bit received data by reading RCREG.
- If any error occurred, clear the error by clearing CREN.

Note: To terminate a reception, either clear the SREN and CREN bits, or the SPEN bit. This will reset the receive logic, so that it will be in the proper state when receive is re-enabled.

FIGURE 13-11: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)



#### FIGURE 14-8: WATCHDOG TIMER BLOCK DIAGRAM



#### TABLE 14-4: REGISTERS/BITS ASSOCIATED WITH THE WATCHDOG TIMER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
_	Config	_	PM1	_	PM0	WDTPS1	WDTPS0	FOSC1	FOSC0	(Note 2)	(Note 2)
06h, Unbanked	CPUSTA	_	-	STKAV	GLINTD	TO	PD	_		11 11	11 qq

Legend: -= unimplemented read as '0', q - value depends on condition, shaded cells are not used by the WDT.

Note 1: Other (non power-up) resets include: external reset through  $\overline{\text{MCLR}}$  and Watchdog Timer Reset.

2: This value will be as the device was programmed, or if unprogrammed, will read as all '1's.

TABLE 15-2: PIC17CXX INSTRUCTION SET (Cont.'d)

Mnemonic,		Description	Cycles		16-bit	Opcod	е	Status	Notes
Operands				MSb			LSb	Affected	
TABLWT	t,i,f	Table Write	2	1010	11ti	ffff	ffff	None	5
TLRD	t,f	Table Latch Read	1	1010	00tx	ffff	ffff	None	
TLWT	t,f	Table Latch Write	1	1010	01tx	ffff	ffff	None	
TSTFSZ	f	Test f, skip if 0	1 (2)	0011	0011	ffff	ffff	None	6,8
XORWF	f,d	Exclusive OR WREG with f	1	0000	110d	ffff	ffff	Z	
BIT-ORIENT	ED FIL	E REGISTER OPERATIONS							
BCF	f,b	Bit Clear f	1	1000	1bbb	ffff	ffff	None	
BSF	f,b	Bit Set f	1	1000	0bbb	ffff	ffff	None	
BTFSC	f,b	Bit test, skip if clear	1 (2)	1001	1bbb	ffff	ffff	None	6,8
BTFSS	f,b	Bit test, skip if set	1 (2)	1001	0bbb	ffff	ffff	None	6,8
BTG	f,b	Bit Toggle f	1	0011	1bbb	ffff	ffff	None	
LITERAL A	ND CO	NTROL OPERATIONS		•					
ADDLW	k	ADD literal to WREG	1	1011	0001	kkkk	kkkk	OV,C,DC,Z	
ANDLW	k	AND literal with WREG	1	1011	0101	kkkk	kkkk	Z	
CALL	k	Subroutine Call	2	111k	kkkk	kkkk	kkkk	None	7
CLRWDT	_	Clear Watchdog Timer	1	0000	0000	0000	0100	TO,PD	
GOTO	k	Unconditional Branch	2	110k	kkkk	kkkk	kkkk	None	7
IORLW	k	Inclusive OR literal with WREG	1	1011	0011	kkkk	kkkk	Z	
LCALL	k	Long Call	2	1011	0111	kkkk	kkkk	None	4,7
MOVLB	k	Move literal to low nibble in BSR	1	1011	1000	uuuu	kkkk	None	
MOVLR	k	Move literal to high nibble in BSR	1	1011	101x	kkkk	uuuu	None	9
MOVLW	k	Move literal to WREG	1	1011	0000	kkkk	kkkk	None	
MULLW	k	Multiply literal with WREG	1	1011	1100	kkkk	kkkk	None	9
RETFIE	_	Return from interrupt (and enable interrupts)	2	0000	0000	0000	0101	GLINTD	7
RETLW	k	Return literal to WREG	2	1011	0110	kkkk	kkkk	None	7
RETURN	_	Return from subroutine	2	0000	0000	0000	0010	None	7
SLEEP	_	Enter SLEEP Mode	1	0000	0000	0000	0011	TO, PD	
SUBLW	k	Subtract WREG from literal	1	1011	0010	kkkk	kkkk	OV,C,DC,Z	
XORLW	k	Exclusive OR literal with WREG	1	1011	0100	kkkk	kkkk	Z	
				_					

Legend: Refer to Table 15-1 for opcode field descriptions.

- Note 1: 2's Complement method.
  - 2: Unsigned arithmetic.
  - 3: If s = '1', only the file is affected: If s = '0', both the WREG register and the file are affected; If only the Working register (WREG) is required to be affected, then f = WREG must be specified.
  - 4: During an LCALL, the contents of PCLATH are loaded into the MSB of the PC and kkkk kkkk is loaded into the LSB of the PC (PCL)
  - 5: Multiple cycle instruction for EPROM programming when table pointer selects internal EPROM. The instruction is terminated by an interrupt event. When writing to external program memory, it is a two-cycle instruction.
  - 6: Two-cycle instruction when condition is true, else single cycle instruction.
  - 7: Two-cycle instruction except for TABLRD to PCL (program counter low byte) in which case it takes 3 cycles.
  - 8: A "skip" means that instruction fetched during execution of current instruction is not executed, instead an NOP is executed.
  - 9: These instructions are not available on the PIC17C42.

CALLSubroutine CallSyntax:[label] CALL kOperands: $0 \le k \le 4095$ Operation: $PC+1 \rightarrow TOS, k \rightarrow PC<12:0>, k<12:8> \rightarrow PCLATH<4:0>; PC<15:13> \rightarrow PCLATH<7:5>$ 

Status Affected: None

Encoding: 111k kkkk kkkk kkkk

Description: Subroutine call within 8K page. First, return address (PC+1) is pushed onto the stack. The 13-bit value is loaded into PC bits<12:0>. Then the upper-eight bits of the PC are copied into PCLATH.

Call is a two-cycle instruction.

See LCALL for calls outside 8K memory appears

space.

Words: 1 Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'<7:0>	Execute	NOP
Forced NOP	NOP	Execute	NOP

Example: HERE CALL THERE

Before Instruction

PC = Address(HERE)

After Instruction

PC = Address(THERE)
TOS = Address(HERE + 1)

Syntax:	[label] CLRF f,s
Operands:	$0 \le f \le 255$
Operation:	$00h \rightarrow f, s \in [0,1]$

Clear f

00h → dest

Status Affected: None

Encoding: 0010 100s fffff ffff

Description: Clears the contents of the specified register(s).

s = 0: Data memory location 'f' and

WREG are cleared.

s = 1: Data memory location 'f' is

cleared.

Words: 1
Cycles: 1

Q Cycle Activity:

**CLRF** 

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register 'f' and other specified register

Example: CLRF FLAG\_REG

Before Instruction

 $FLAG_REG = 0x5A$ 

After Instruction

 $FLAG_REG = 0x00$ 

RLNCF		Rota	te L	eft f (no	carı	y)	
Syntax:		[ labe	e/]	RLNCF	f,d		
Operands:		0 ≤ f d ∈ [		55			
Operation:		f <n> f&lt;7&gt;</n>		<n+1>; &lt;0&gt;</n+1>			
Status Affe	ected:	None	)				
Encoding:		0.0	10	001d	ff	ff	ffff
Description	n:	one b place	it to d in \	nts of reg the left. If WREG. If kk in regis	'd' is 'd' is	0 the 1 the	result is
			•	reg	ister	f	]◀┐
Words:		1					
Cycles:		1					
Q Cycle A	ctivity:						
	21	Q2		Q3			Q4
Dec	code	Read registe	-	Execu	te		rite to tination
Example:		RLNC	F	REC	3, 1		
Before	e Instru	iction					
C R	: EG	= 0 = 11	10 1	.011			
	nstruct	tion					
C R	: EG	= = 11	01 (	)111			

RRCF	Rotate Right f through Carry				
Syntax:	[ label ]	RRCF	f,d		
Operands:	$0 \le f \le 25$ $d \in [0,1]$	55			
Operation:	$f$ < $n$ > $\rightarrow 0$ $f$ < $0$ > $\rightarrow 0$ $C$ $\rightarrow d$ < $7$	<b>)</b> ;			
Status Affected:	С				
Encoding:	0001	100d	fff	f ffff	
Description:	The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is placed back in register 'f'.				
Words:	1				
Cycles:	1				
Q Cycle Activity:					
Q1	Q2	Q3		Q4	
Decode	Read register 'f'	Execu	ıte	Write to destination	
Example:	RRCF	1	REG1,	0	
Before Instru	iction				
REG1 C	= 1110 = 0	0110			
After Instruction					
REG1	= 1110	0110			
WREG C		0011			

## PIC17C4X

Applicable Devices | 42 | R42 | 42A | 43 | R43 | 44

FIGURE 18-9: TYPICAL IPD vs. VDD WATCHDOG DISABLED 25°C

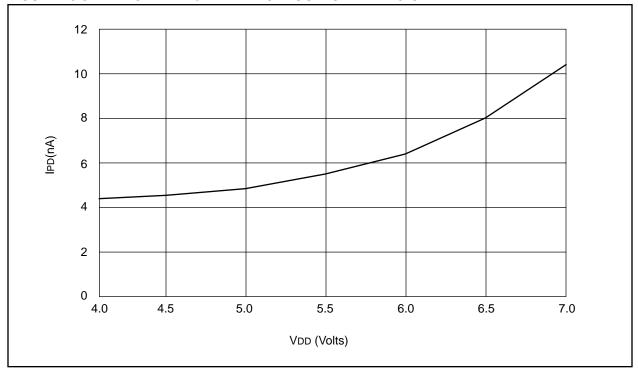
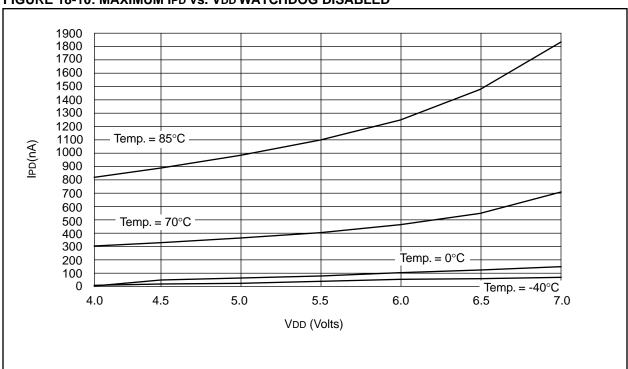


FIGURE 18-10: MAXIMUM IPD vs. VDD WATCHDOG DISABLED



Applicable Devices | 42 | R42 | 42A | 43 | R43 | 44

FIGURE 18-11: TYPICAL IPD vs. VDD WATCHDOG ENABLED 25°C

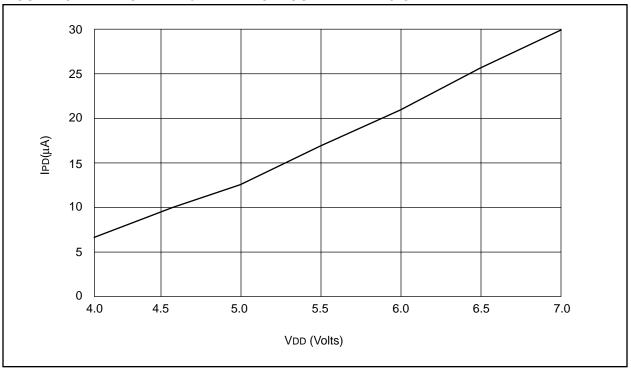
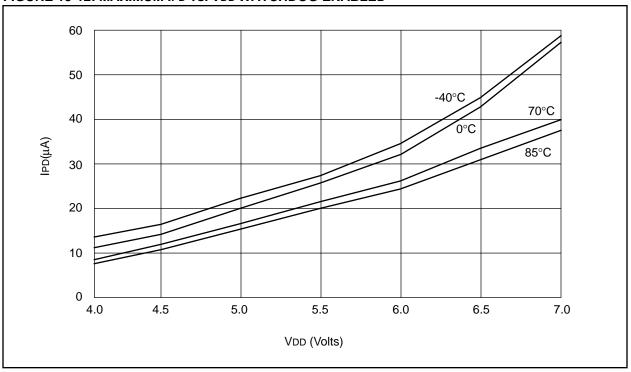


FIGURE 18-12: MAXIMUM IPD vs. VDD WATCHDOG ENABLED



Applicable Devices 42 R42 42A 43 R43 44

FIGURE 19-3: CLKOUT AND I/O TIMING

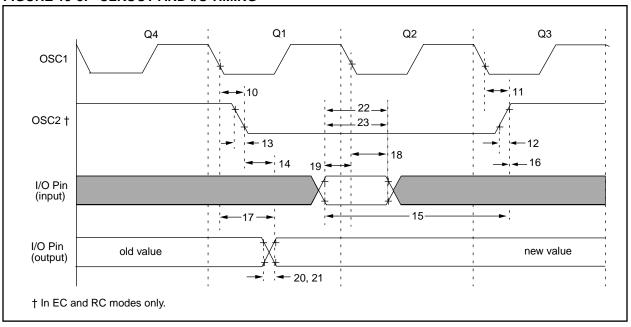


TABLE 19-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
10	TosH2ckL	OSC1↓ to CLKOUT↓		_	15 ‡	30 ‡	ns	Note 1
11	TosH2ckH	OSC1↓ to CLKOUT↑		_	15 ‡	30 ‡	ns	Note 1
12	TckR	CLKOUT rise time		_	5‡	15 ‡	ns	Note 1
13	TckF	CLKOUT fall time		_	5‡	15 ‡	ns	Note 1
14	TckH2ioV	CLKOUT ↑ to Port out valid	PIC17CR42/42A/43/ R43/44	_	_	0.5Tcy + 20 ‡	ns	Note 1
			PIC17LCR42/42A/43/ R43/44	_	_	0.5Tcy + 50 ‡	ns	Note 1
15	TioV2ckH	Port in valid before CLKOUT↑	PIC17CR42/42A/43/ R43/44	0.25Tcy + 25 ‡	_	_	ns	Note 1
			PIC17LCR42/42A/43/ R43/44	0.25Tcy + 50 ‡	_	_	ns	Note 1
16	TckH2iol	Port in hold after CL	KOUT <sup>↑</sup>	0 ‡	_	_	ns	Note 1
17	TosH2ioV	OSC1↓ (Q1 cycle) t	o Port out valid	_	_	100 ‡	ns	
18	TosH2iol	OSC1↓ (Q2 cycle) to Port input invalid (I/O in hold time)		0 ‡	_	_	ns	
19	TioV2osH	Port input valid to OSC1↓ (I/O in setup time)		30 ‡	_	_	ns	
20	TioR	Port output rise time		_	10 ‡	35 ‡	ns	
21	TioF	Port output fall time		_	10 ‡	35 ‡	ns	
22	TinHL	INT pin high or low time		25 *	_	_	ns	
23	TrbHL	RB7:RB0 change IN	NT high or low time	25 *	_	_	ns	

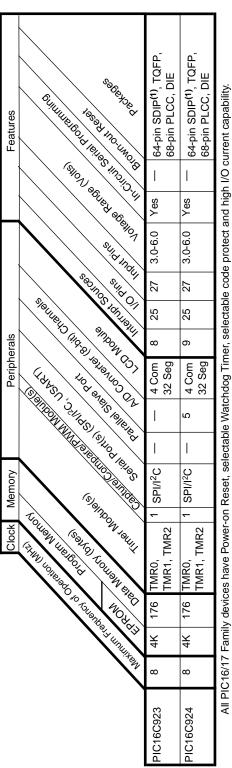
<sup>\*</sup> These parameters are characterized but not tested.

<sup>†</sup> Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

These parameters are for design guidance only and are not tested, nor characterized.

Note 1: Measurements are taken in EC Mode where CLKOUT output is 4 x Tosc.

#### E.7 PIC16C9XX Family Of Devices



All PIC16CXX Family devices use serial programming with clock pin RB6 and data pin RB7. Please contact your local Microchip representative for availability of this package. Note

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